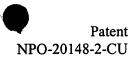
1-5 (Cancelled)

- 6 (Original) A carbon based protective padding for a MEMS device, the carbon based protective padding further adapted to accurately and reliably establish a one nanometer spacing between a conducting surface on the MEMS device and a tunneling tip, the carbon based protective padding comprising a film of fullerene C₆₀ having a thickness of one molecule, said film located at the conducting surface between the tunneling tip and the conducting surface.
- 7 (Previously Added) A microelectromechanical system (MEMS) device including a diaphragm comprising a conducting surface, the MEMS device further comprising exactly one layer of C_{60} fullerene on the conducting surface.
- 8 (Previously Added) The MEMS device of claim 7, wherein the conducting surface includes gold.
- 9 (Previously Added) The MEMS device of claim 8, where the C_{60} fullerene is deposed on the gold surface by sublimation.
- 10 (Previously Added) The MEMS device of claim 8 where the C_{60} fullerene is deposited on the gold surface by chemisorbtion.
- 11 (Previously Added) The MEMS device of claim 7 further comprising a single event pipe containing a gas that reacts with carbon byproducts.
- 12 (Previously Added) A mechanically adjustable electron tunneling tip system comprising:





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a tunneling tip including a piezoelectric element connected to an end of the tunneling tip;

a MEMS device including a conducting surface opposed the tunneling tip; and

a single layer of C_{60} fullerene between the tunneling tip and the MEMS device conducting surface.